



Product Description

- The 0603 SMD LED is much smaller, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- These LEDs have high reliability performance and are designed to work under a wide range of environmental conditions.
- Besides, lightweight makes them ideal for miniature applications. etc.

Features

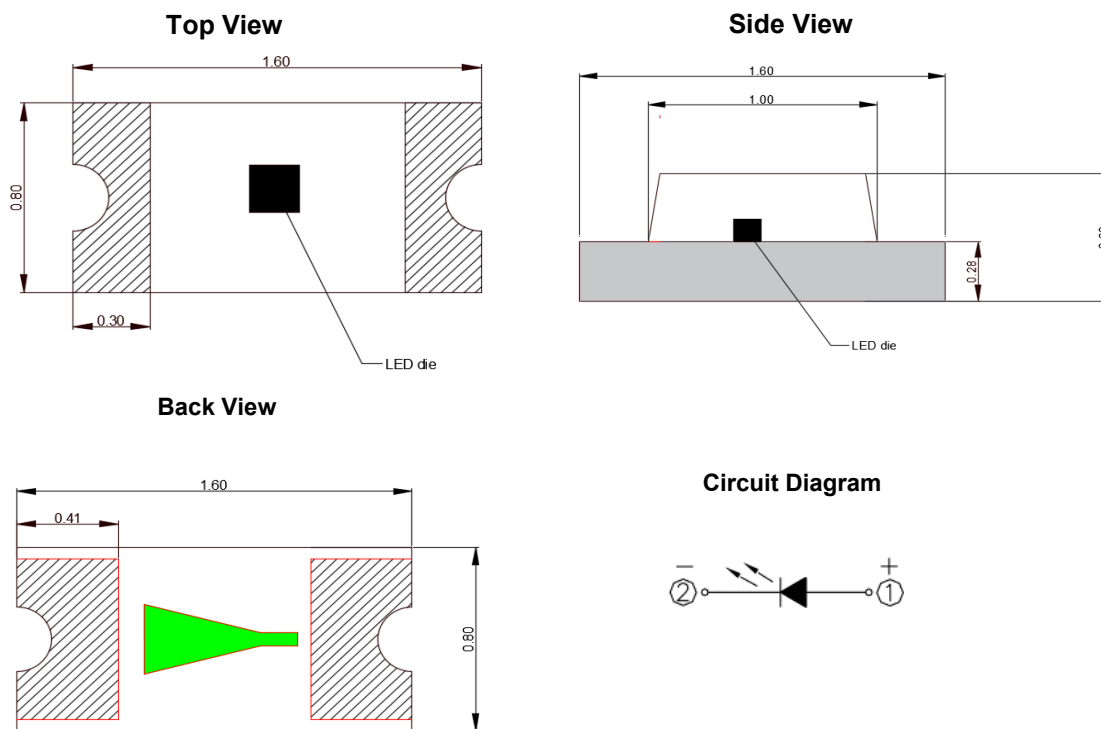
- Size(mm): 1.6*0.8*0.6mm
- Compatible with automatic placement equipment
- Moisture Sensitivity Level: 3
- Color type: Green
- Viewing Angle:120°
- Pb-free
- RoHS and REACH compliant

Applications

- Backlighting in dashboard and switch.
- Digital display for household appliance
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD
- General use

MECHANICAL DIMENSIONS

All dimensions are in mm.



Remark

The tolerance of all dimensions above is 0.1mm.



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$)

Items	Symbol	Absolute Maxium Rating	Unit
Forward current	I_F	20	mA
Peak Forward Crurrent	I_{FP}	60	mA
Reverse voltage	V_R	5	V
Power dissipation	P_D	100	mW
Operating temperature	T_{opr}	-40 ~+85	$^\circ\text{C}$
Storage temperature	T_{stg}	-40~+100	$^\circ\text{C}$

Remark: 1/10 Duty cycle, 0.1ms pulse width.

TYPICAL ELECTRICAL & OPTICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$)

Charateristics	Symbol	Condition	Unit	Minimum	Typical
Forward Volatge	V_F	$I_F=5\text{mA}$	V		2.7
Reverse Current	V_R	$V_R=5\text{V}$	uA		<1
Viewing Angle	$2\theta_{1/2}$	$I_F=5\text{mA}$			120
Luminous intensity	I_V	$I_F=5\text{mA}$	mcd	145	
Spectral Line Half-Width	$\Delta\lambda$	$I_F=5\text{mA}$	nm		15
Dominant Wavelength	λ_d	$I_F=5\text{mA}$	nm	519	
Peak Wavelength	λ_p	$I_F=5\text{mA}$	nm		520

* Continuous reverse voltage can cause LED damage.



INTENSITY BIN LIMIT

Green (5mA)		
Bin code	Min.(mcd)	Max.(mcd)
GM1	145	175
GM2	175	210
GM3	210	250
GM4	250	300
GM5	300	360

*Tolerance of measurement of luminous intensity is $\pm 10\%$.

VOLTAGE BIN LIMIT

Green (5mA)		
Bin code	Min.(V)	Max.(V)
GV1	2.4	2.5
GV2	2.5	2.6
GV3	2.6	2.7
GV4	2.7	2.8
GV5	2.8	2.9
GV6	2.9	3.0

*Tolerance of measurement of voltage is $\pm 0.05V$.

Color BIN LIMIT

Green (5mA)		
Bin code	Min.(nm)	Max.(nm)
GD1	519	522
GD2	522	525
GD3	525	528
GD4	528	531

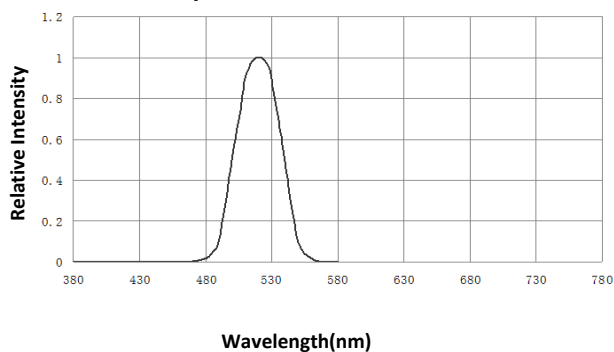
*Tolerance of measurement of wavelength is $\pm 1nm$



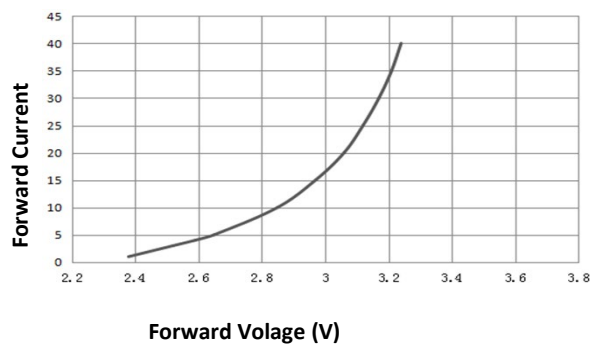
TYPICAL ELECTRO-OPTICAL CHARACTERISTICS CURES($T_a=25^{\circ}\text{C}$)

The data below are collected from statistical figures that do not necessarily correspond to the actual parameters of each single LED. Hence, these data will be changed without further notice.

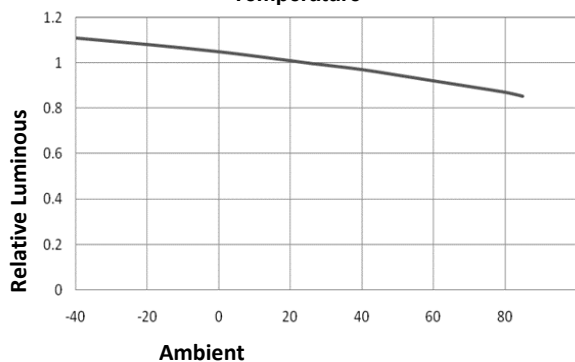
Spectrum Distribution



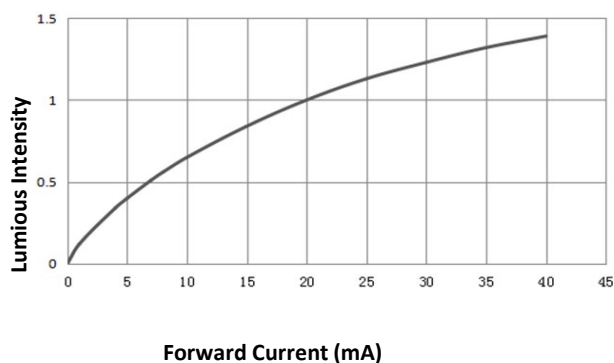
Forward Current vs. Forward Voltage



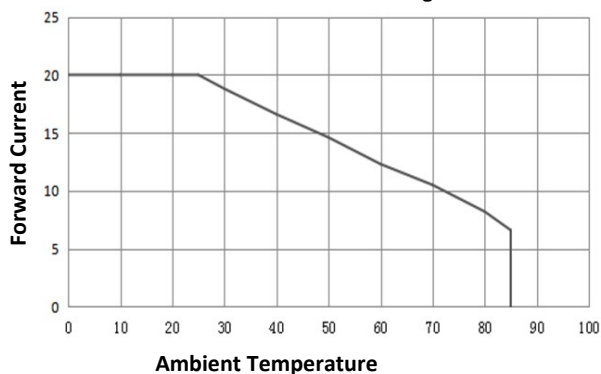
Luminous Intensity vs. Ambient Temperature



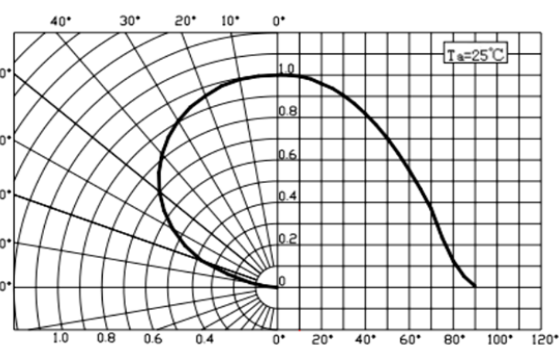
Luminous Intensity vs. Forward Current



Forward Current Derating

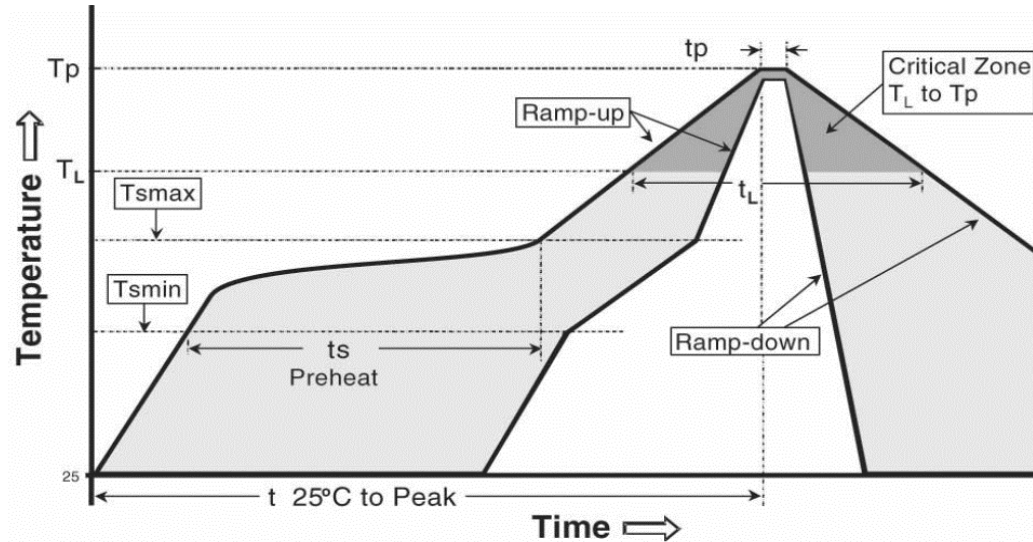


Radiation Diagram



REFLOW SOLDERING

- The CHIP LED is rated as a MSL3 as general request product.
- The recommended floor life out of bag is 24hrs.
- The temperature profile is as below.



IPC/JEDEC J-STD-020C	
Profile Feature	Pb-Free Assembly
Average ramp-up rate(Tsmax to Tp)	3°C/second max.
Preheat	
- Temperature Min(Tsmin)	150°C
- Temperature Max(Tsmax)	200°C
- Time(Tsmin to Tsmax)	60-180 seconds
Time maintained above	
- Temperature(T _L)	217°C
- Time(T _L)	60-150 seconds
Peak Temperature(Tp)	260°C
Time within 5°C of actual peak Temperature(tp) ²	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to peak Temperature	8 minutes max.



Moisture Sensitivity

- Beking recommends keeping CHIP LEDs in the provided, resealable moisture-barrier packaging (MBP) until immediately prior to soldering. Unopened MBPs that contain CHIP LEDs do not need special storage for moisture sensitivity.
- Once the MBP is opened, CHIP LEDs may be stored as MSL 3 per IPC/JEDEC J-STD-020C, meaning they have one year of floor life in conditions of $\leq 30\text{ }^{\circ}\text{C}/60\%$ relative humidity (RH). Regardless of the storage condition, Beking LED recommends sealing any unsoldered CHIP LEDs in the original MBP.

Handling

- The packaging sizes of these SMD products are very small. Users are required to handle with care.
- To avoid damaging the product's surface and interior device, it is recommended to choose a

Repairing

Repair should not be recommended after SMT production. When repairing is needed, a double-head soldering iron should be used (as below figure). It should be assured before handing whether the electrical and optical characteristics of the LEDs will or will not be damaged by

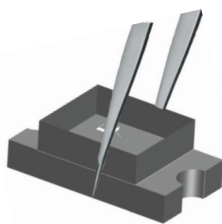


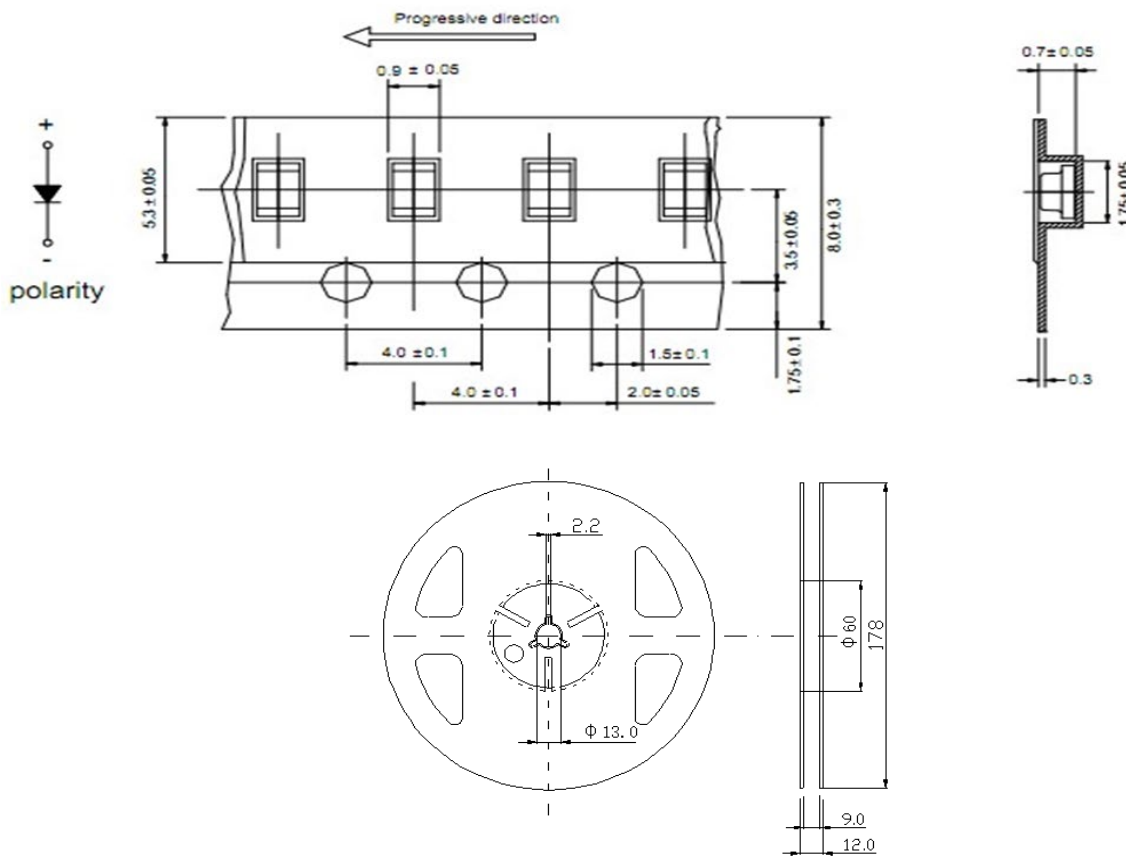
Fig.1 Pickig up a LED using an tweezer with care



Fig2. Repairing using a double-head soldering iron

PACKING

Carrier Tape Dimensions: Loaded quantity 4000pcs per reel.



All dimensions are in millimeters.

Tolerance of measurement of all dimensions is ± 0.1 mm

